# Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Solid State Relay OCMOS FET

# PS7241E-1A

# 4-PIN SOP 400 V BREAK DOWN VOLTAGE NORMALLY OPEN TYPE 1-ch Optical Coupled MOS FET -NEPOC Series-

#### **DESCRIPTION**

The PS7241E-1A is an optically coupled element that combines a GaAs infrared LED on the input side with a normally-open MOS FET on the output side to realize an excellent cost performance.

The small, thin package and high sensitivity of this element makes it ideal for battery-driven mobile devices, and its small offset voltage at power-on and good linearity are also make it suitable for controlling micro analog signals.

#### **FEATURES**

- Small and thin package (4-pin SOP, Height = 2.1 mm)
- 1 channel type (1 a output)
- · Designed for AC/DC switching line changer
- Low offset voltage

<R> • Ordering number

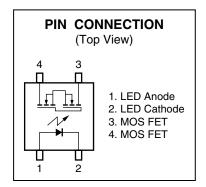
Ordering number of taping product: PS7241E-1A-E3, E4: 900 pcs/reel
 : PS7241E-1A-F3, F4: 3 500 pcs/reel

- Pb-Free product
- Safety standards

UL approved: No. E72422BSI approved: No. 8241/8242

#### **APPLICATIONS**

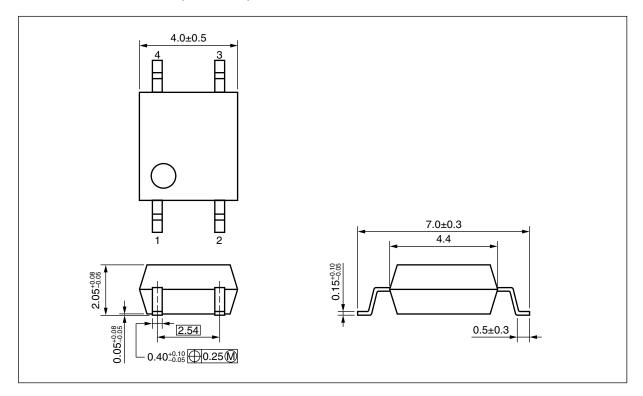
- · Laptop PC, PDA
- Modem card
- · Telephone, FAX
- · Measurement equipment



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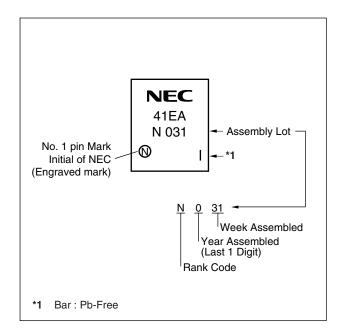
## PACKAGE DIMENSIONS (UNIT: mm)



### <R> PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)		
Air Distance	5 mm		
Outer Creepage Distance	5 mm		
Isolation Distance	0.4 mm		

#### <R> MARKING EXAMPLE





#### **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number   ¹
PS7241E-1A	PS7241E-1A-A	Pb-Free	Magazine case 100 pcs	Standard products	PS7241E-1A
PS7241E-1A-E3	PS7241E-1A-E3-A		Embossed Tape 900 pcs/reel	(UL, BSI approved)	
PS7241E-1A-E4	PS7241E-1A-E4-A				
PS7241E-1A-F3	PS7241E-1A-F3-A		Embossed Tape 3 500 pcs/reel		
PS7241E-1A-F4	PS7241E-1A-F4-A				

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	50	mA
	Reverse Voltage	VR	5.0	V
	Power Dissipation	Po	50	mW
	Peak Forward Current <sup>*1</sup>	IFP	1	Α
MOS FET	Break Down Voltage	VL	400	V
	Continuous Load Current	l <sub>L</sub>	120	mA
	Pulse Load Current <sup>2</sup> (AC/DC Connection)	ILP	240	mA
	Power Dissipation	Po	300	mW
Isolation Vo	oltage *3	BV	1 500	Vr.m.s.
Total Power Dissipation		Рт	350	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		T <sub>stg</sub>	-40 to +100	°C

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1%

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<sup>\*2</sup> PW = 100 ms, 1 shot

<sup>\*3</sup> AC voltage for 1 minute at T<sub>A</sub> = 25°C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.

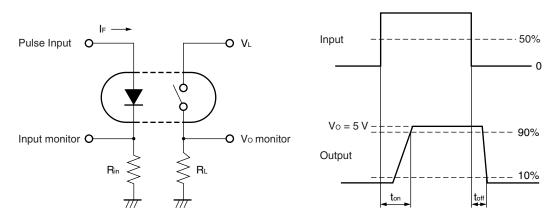
### RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	4	10	20	mA
LED Off Voltage	VF	0		0.5	V

### **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	٧
	Reverse Current	lR	V <sub>R</sub> = 5 V			5.0	μΑ
MOS FET	Off-state Leakage Current	ILoff	V <sub>D</sub> = 400 V			1.0	μΑ
	Output Capacitance	Cout	V <sub>D</sub> = 0 V, f = 1 MHz		50		pF
Coupled	LED On-state Current	IFon	I∟ = 120 mA			4.0	mA
	On-state Resistance	Ron1	IF = 10 mA, IL = 10 mA		22	30	Ω
		Ron2	$I_F = 10 \text{ mA}, I_L = 120 \text{ mA}, t \le 10 \text{ ms}$		17	23	
	Turn-on Time <sup>*1, 2</sup>	ton	IF = 10 mA, Vo = 5 V, RL = 500 $\Omega$ ,		0.5	1.0	ms
	Turn-off Time <sup>*1, 2</sup>	toff	PW ≥ 10 ms		0.07	0.2	
	Isolation Resistance	R <sub>I-O</sub>	Vi-o = 1.0 kVpc	10°			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1 MHz		0.5		pF

#### \*1 Test Circuit for Switching Time



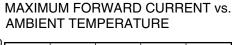
\*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.

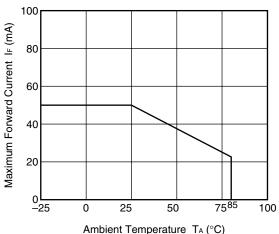
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

<R>

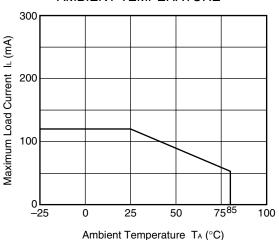
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#### TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

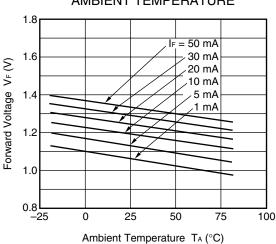




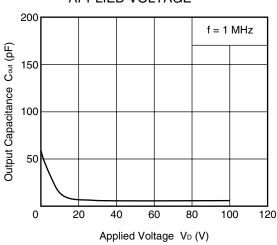
MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



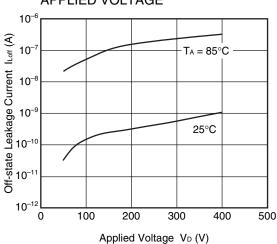
# FORWARD VOLTAGE vs. AMBIENT TEMPERATURE



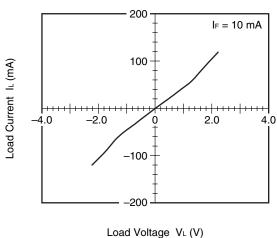
OUTPUT CAPACITANCE vs. APPLIED VOLTAGE



# OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE

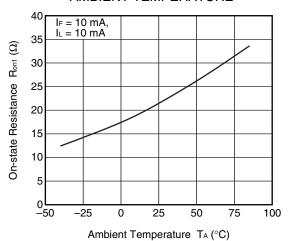


LOAD CURRENT vs. LOAD VOLTAGE

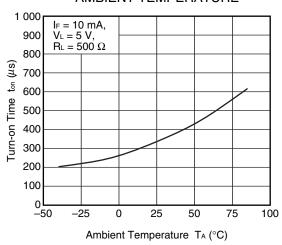


Remark The graphs indicate nominal characteristics.

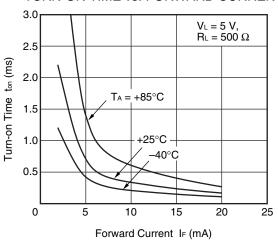
# ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



# TURN-ON TIME vs. AMBIENT TEMPERATURE

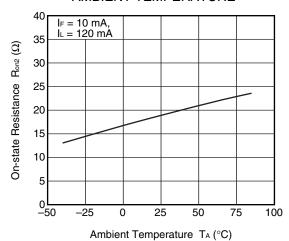


#### TURN-ON TIME vs. FORWARD CURRENT

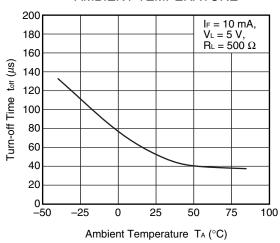


**Remark** The graphs indicate nominal characteristics.

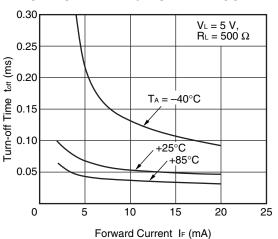
# ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



# TURN-OFF TIME vs. AMBIENT TEMPERATURE

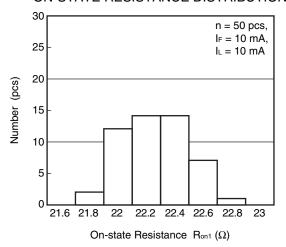


#### TURN-OFF TIME vs. FORWARD CURRENT

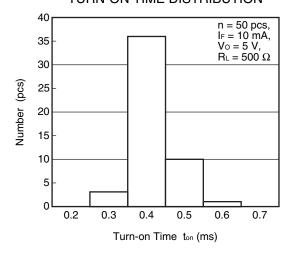


# **NEC**

#### **ON-STATE RESISTANCE DISTRIBUTION**

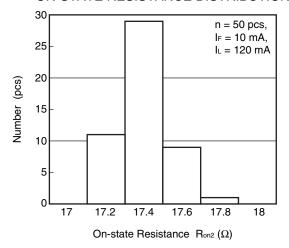


# TURN-ON TIME DISTRIBUTION

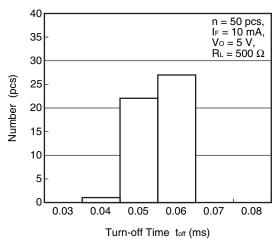


**Remark** The graphs indicate nominal characteristics.

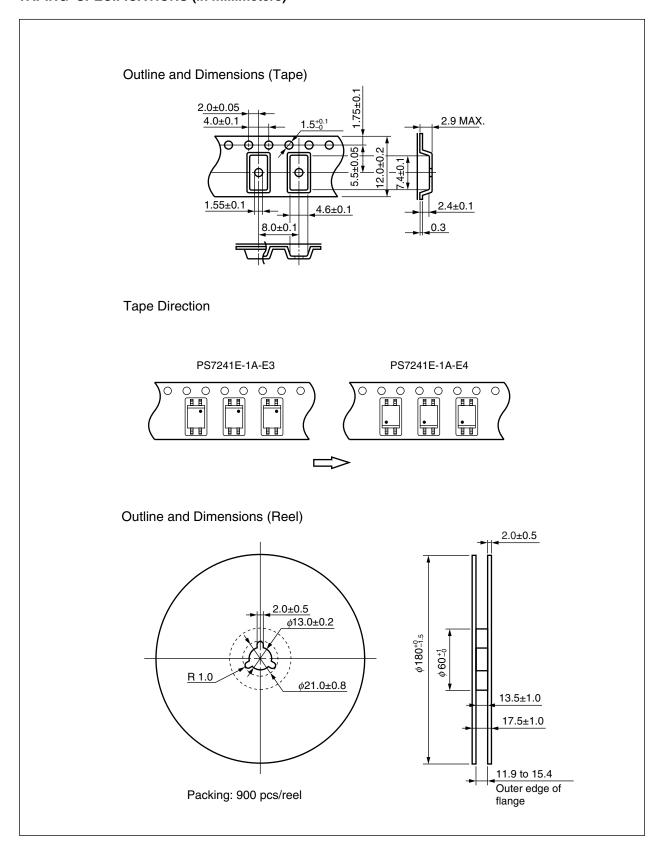
#### **ON-STATE RESISTANCE DISTRIBUTION**



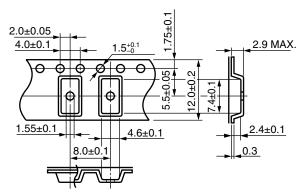
#### TURN-OFF TIME DISTRIBUTION



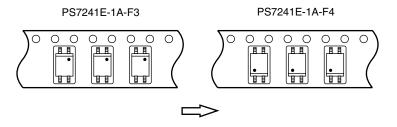
# **TAPING SPECIFICATIONS (in millimeters)**



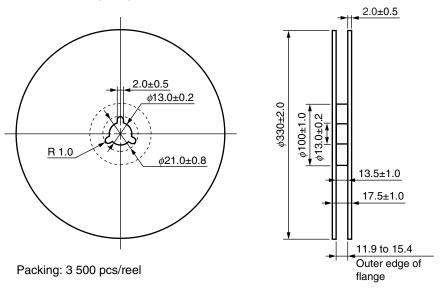
### Outline and Dimensions (Tape)



### **Tape Direction**



### Outline and Dimensions (Reel)



#### RECOMMENDED SOLDERING CONDITIONS

#### (1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

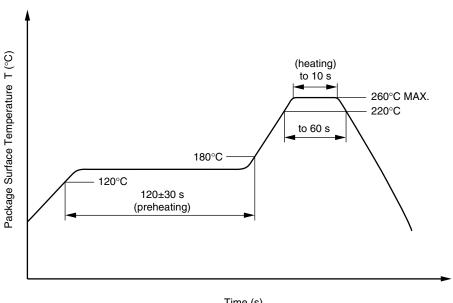
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



#### Time (s)

#### (2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine • Flux

content of 0.2 Wt% is recommended.)

#### (3) Soldering by soldering iron

• Peak temperature (lead part temperature) 350°C or below • Time (each pins) 3 seconds or less

 Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

#### (4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

### **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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NEC PS7241E-1A

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Cai	ution	

**GaAs Products** 

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.